

**AMENDMENTS TO THE SPECIFICATION**

Please replace the TITLE with the following amended TITLE:

A Method of Shielding an Electronic Card with a Printed Circuit Electronics Card

Mounted on a Metal Substrate.

**AMENDMENTS TO THE CLAIMS**

Claims 4, 5 and 7 are pending in this application. Claims 4 and 5 are herein amended.

The listing of claims will replace all prior versions, and listings, of claims in the application.

**Listing of Claims**

1-3. (Canceled)

4. (Currently Amended) A method of producing an assembly comprising a printed-circuit electronics card mounted on a metal substrate with a metal screening cover electrically connected to the metal substrate, the method comprising:

forming a gutter on a the ~~metallie~~ substrate by stamping;

mounting a the printed circuit electronics card onto a surface of the ~~metallie~~ substrate adjacent to the gutter;

positioning a the metal screening cover having an edge including a tab so that the tab rests substantially within the gutter; and